



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	Ι _D Τ _A = 25°C	
-40V	11mΩ @ V_{GS} = -10V	-14.0A	
	$15m\Omega @ V_{GS} = -4.5V$	-12.0A	

Description and Applications

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power management functions
- Backlighting

Features and Benefits

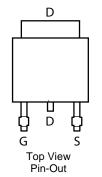
- 100% Unclamped Inductive Switch (UIS) test in production
- Low on-resistance
- Fast switching speed
- "Green" component and RoHS compliant (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

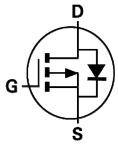
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.33 grams (approximate)



Top View





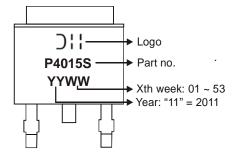
Equivalent Circuit

Ordering Information (Note 2)

Part Number	Qualification	Case	Packaging
DMP4015SK3-13	Commercial	TO252	2,500/Tape & Reel
DMP4015SK3Q-13	Automotive	TO252	2,500/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. Halogen and Antimony free. 2. For packaging details, go to our website at http://www.diodes.com.

Marking Information





Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-40	V
Gate-Source Voltage			V _{GSS}	±25	V
Continuous Drain Current (Note 3) V _{GS} = -10V	Steady State	T _A = 25°C T _A = 70°C	ID	-10.5 -8.2	А
	t<10s	T _A = 25°C T _A = 70°C	ID	-16.5 -13.0	A
Continuous Drain Current (Note 4) V_{GS} = -10V	Steady State	T _A = 25°C T _A = 70°C	ID	-14.0 -11.0	А
	t<10s	T _A = 25°C T _A = 70°C	ID	-22.1 -17.7	A
Pulsed Drain Current (10μs pulse, duty cycle = 1%)			IDM	-100	A
Maximum Body Diode Forward Current (Note 4)			I _S	-5.5	А
Avalanche Current (Note 5)			IAS	-57	A
Avalanche Energy (Note 5)			E _{AS}	162	mJ

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units
Total Bawar Dissinction (Nata 2)	T _A = 25°C	D	2.0	W
Total Power Dissipation (Note 3)	T _A = 70°C	PD	1.3	
Thermal Resistance, Junction to Ambient (Note 3)	Steady state	Р	61	°C/W
	t<10s	$R_{ extsf{ heta}JA}$	24	
Total Dower Dissipation (Note 4)	$T_A = 25^{\circ}C$	Π-	3.5	W
Total Power Dissipation (Note 4)	T _A = 70°C	PD	2.2	
Thermal Resistance, Junction to Ambient (Note 4)	Steady state	P	36	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	t<10s	$R_{ heta}JA$	15	
Thermal Resistance, Junction to Case (Note 4)	Steady state	$R_{\theta JC}$	4.5	
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)						÷	
Drain-Source Breakdown Voltage	BV _{DSS}	-40	_	—	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		-1	μA	$V_{DS} = -40V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 25 V$, $V_{DS} = 0 V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	-1.5	-2.0	-2.5	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
Static Drain-Source On-Resistance	D	_	7	11	mΩ	$V_{GS} = -10V, I_D = -9.8A$	
	R _{DS (ON)}	_	9	15	1115.2	$V_{GS} = -4.5V, I_D = -9.8A$	
Forward Transfer Admittance	Y _{fs}	_	26	_	S	$V_{DS} = -20V, I_D = -9.8A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.0	V	$V_{GS} = 0V, I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}	_	4234			V _{DS} = -20V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	C _{oss}	_	1036	_	pF		
Reverse Transfer Capacitance	C _{rss}	—	526	—			
Gate Resistance	R _G	_	7.77		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge	Qg	_	47.5	_			
Gate-Source Charge	Q _{gs}	_	14.2	_	nC	V _{DS} = -20V, V _{GS} = -5V I _D = -9.8A	
Gate-Drain Charge	Q _{gd}	_	13.5	_			
Turn-On Delay Time	t _{D(on)}		13.2	_		V_{GS} = -10V, V_{DD} = -20V, R _G = 6Ω, I _D = -1A	
Turn-On Rise Time	tr		10.0				
Turn-Off Delay Time	t _{D(off)}	_	302.7	_	ns		
Turn-Off Fall Time	t _f		137.9	—]		

3. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

4. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate

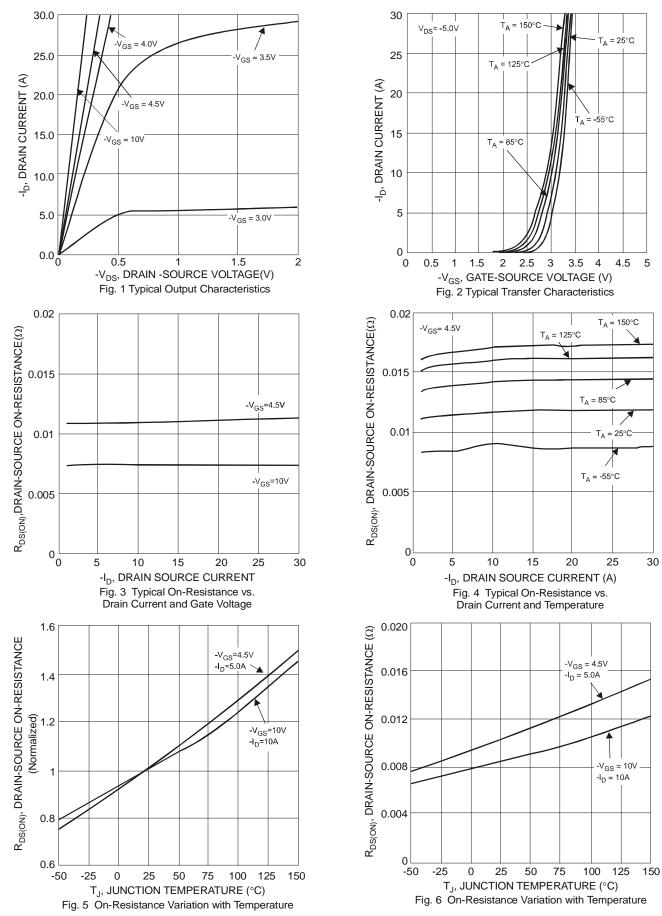
5. UIS in production with L = 0.1mH, TJ = $25^{\circ}C$

6 .Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to production testing.

Notes:

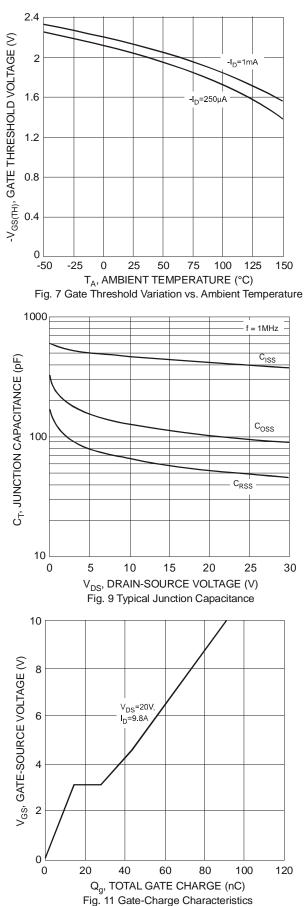


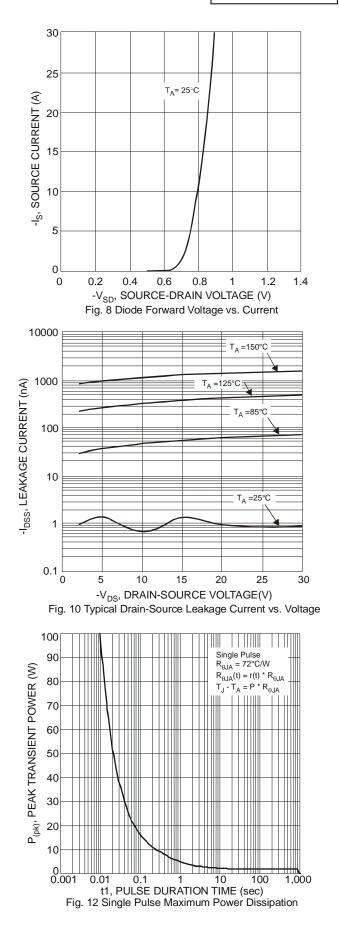
DMP4015SK3





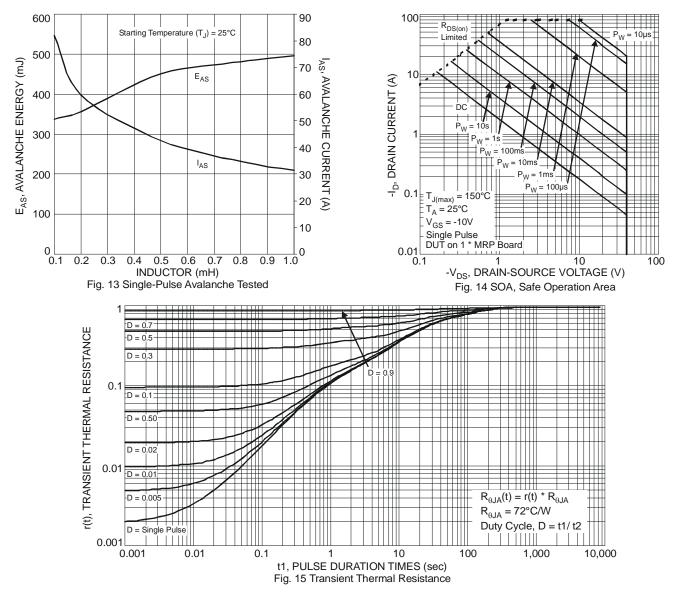






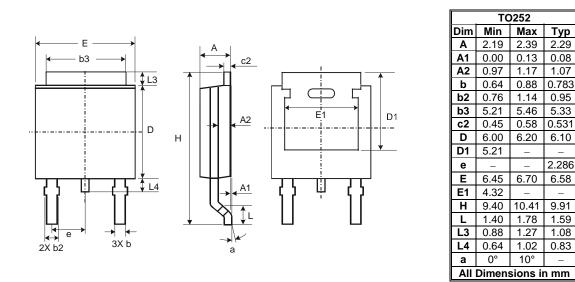


DMP4015SK3

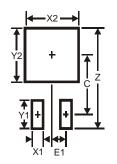




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
Z	11.6
X1	1.5
X2	7.0
Y1	2.5
Y2	7.0
С	6.9
E1	2.3



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